XP133A1235SR

Power MOSFET

■GENERAL DESCRIPTION

The XP133A1235SR is an N-channel Power MOSFET with low on-state resistance and ultra high-speed switching characteristics. Two FET devices are built into the one package

Because high-speed switching is possible, the IC can be efficiently set thereby saving energy.

The small SOP-8 package makes high density mounting possible.

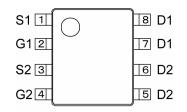
■APPLICATIONS

- Notebook PCs
- Cellular and portable phones
- On-board power supplies
- Li-ion battery systems

■FEATURES

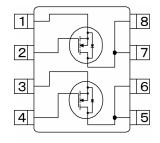
Low On-State Resistance : $Rds(on)=0.035 \Omega$ (Vgs= 4.5V) : Rds(on)=0.048 Ω (Vgs = 2.5V) **Ultra High-Speed Switching Driving Voltage** : 2.5V **N-Channel Power MOSFET DMOS Structure Two FET Devices Built-in** Package : SOP-8

■PIN CONFIGURATION



SOP-8 (TOP VIEW)

■EQUIVALENT CIRCUIT



N-channel MOSFET (2 FET devices built-in)

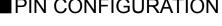
■PIN ASSIGNMENT

PIN NUMBER	PIN NAME	FUNCTION
1	S1	Source
2	G1	Gate
3	S2	Source
4	G2	Gate
5~6	D2	Drain
7~8	D1	Drain

■ABSOLUTE MAXIMUM RATINGS

Ta = 25°C						
PARAMETER	SYMBOL	RATINGS	UNITS			
Drain-Source Voltage	Vdss	20	V			
Gate-Source Voltage	Vgss	±12	V			
Drain Current (DC)	ld	6	А			
Drain Current (Pulse)	ldp	20	А			
Reverse Drain Current	ldr	6	А			
Channel Power Dissipation *	Pd	2	W			
Channel Temperature	Tch	150	°C			
Storage Temperature Range	Tstg	-55~150	°C			

* When implemented on a glass epoxy PCB



~ = 0 -

■ELECTRICAL CHARACTERISTICS

DC Characteristics

DC Characteristics Ta = 25						
PARAMETER	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS
Drain Cut-Off Current	ldss	Vds=20V, Vgs=0V	-	-	10	μA
Gate-Source Leak Current	lgss	Vgs=±12V, Vds=0V	-	-	±1	μA
Gate-Source Cut-Off Voltage	Vgs(off)	ld=1mA, Vds=10V	0.5	-	1.2	V
Drain-Source On-State Resistance *	Rds(on)	ld=3A, Vgs=4.5V	-	0.026	0.035	Ω
		ld=3A, Vgs=2.5V	-	0.035	0.048	Ω
Forward Transfer Admittance *	Yfs	ld=4A, Vds=10V	-	14	-	S
Body Drain Diode Forward Voltage	Vf	lf=6A, Vgs=0V	-	0.85	1.1	V

* Effective during pulse test.

Dynamic Characteristics

Dynamic Characteristics Ta					a = 25°C	
PARAMETER	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS
Input Capacitance	Ciss	Vds=10V, Vgs=0V f=1MHz	-	760	-	pF
Output Capacitance	Coss		-	430	-	pF
Feedback Capacitance	Crss		-	200	-	pF

Switching Characteristics

Switching Characteristics					Т	a = 25°C
PARAMETER	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS
Turn-On Delay Time	td (on)	Vgs=5V, Id=3A Vdd=10V	-	10	-	ns
Rise Time	tr		-	20	-	ns
Turn-Off Delay Time	td (off)		-	55	-	ns
Fall Time	tf		-	15	-	ns

Thermal Characteristics

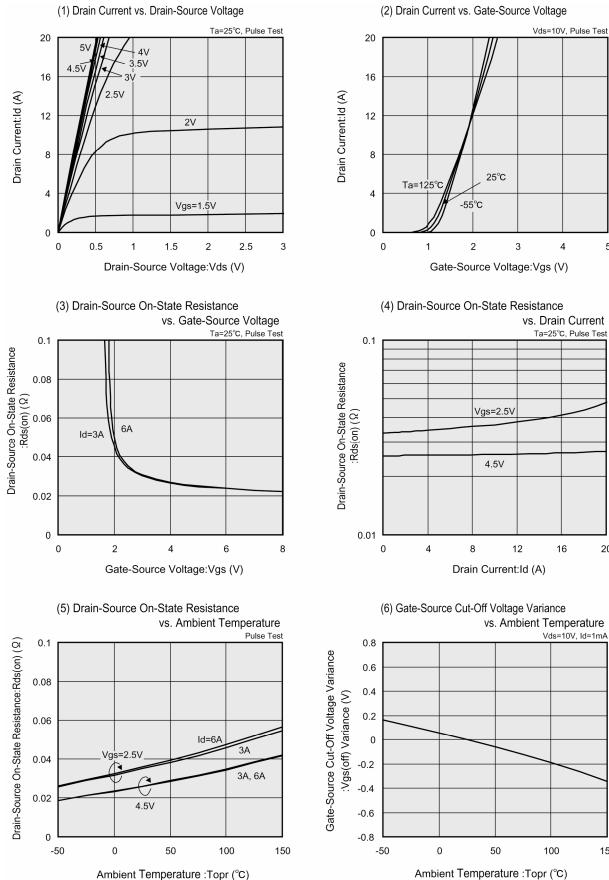
PARAMETER	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS
Thermal Resistance (Channel-Ambience)	Rth (ch-a)	Implement on a glass epoxy resin PCB	-	62.5	-	°C/W

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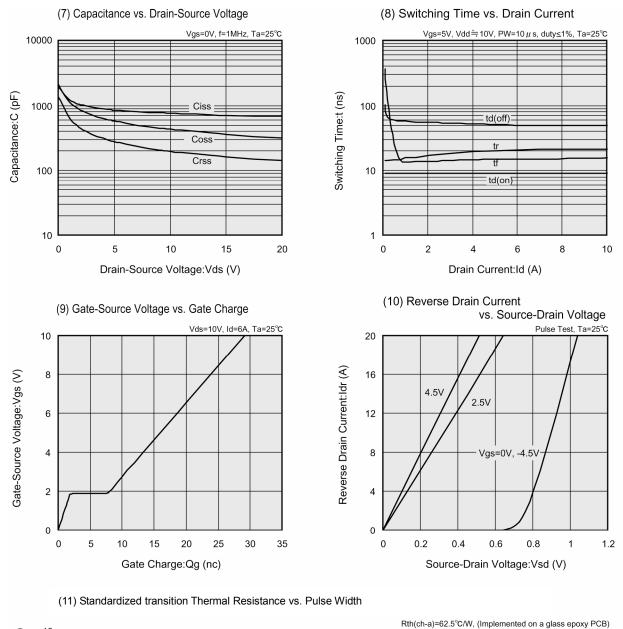
TYPICAL PERFORMANCE CHARACTERISTICS

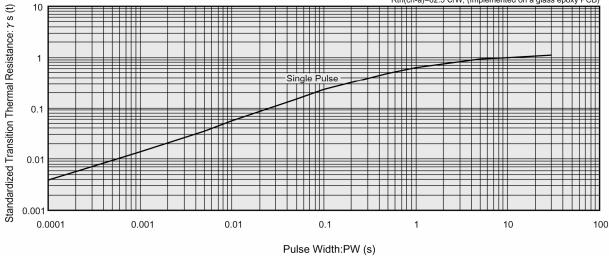


Ambient Temperature :Topr (°C)

150

■TYPICAL PERFORMANCE CHARACTERISTICS (Continued)





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